

DATA SHEET

SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS

Automotive grade Array

NPO/X7R |6 V TO 50 V sizes 0508 (4 x 0402) / 0612 (4 x 0603)

RoHS compliant & Halogen Free



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Surface-Mount Ceramic Multilayer Capacitors Automotive Array NP0/X7R 16 V to 50 V

<u>SCOPE</u>

This specification describes Automotive grade NP0/X7R series chip capacitors with lead-free terminations and used for automotive equipments.

APPLICATIONS

- Professional electronics
- High density consumer electronics

FEATURES

- AEC-Q200 qualified
- MSL class: MSL I
- AC series soldering is compliant with J-STD-020D
- 0508 (4x0402) / 0612 (4x0603) capacitors (of the same capacitance value) per array
- Less than 50% board space of an equivalent discrete component
- Increased throughout, by time saved in mounting
- RoHS compliant & Halogen free
- The capacitors are 100% performed by automatic optical inspection prior to taping.

ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

YAGEO BRAND ordering code GLOBAL PART NUMBER (PREFERRED)

AC <u>xxxx</u> <u>x</u> <u>x</u> <u>xxx</u> <u>x</u> B <u>x</u> <u>xxx</u> (1) (2) (3) (4) (5) (6) (7)

(I) SIZE - INCH BASED (METRIC)

0508 (1220) 0612 (1632)

(2) TOLERANCE

- J = ±5%
- $K = \pm 10\%$
- $M = \pm 20\%$

(3) PACKING STYLE

- R = Paper/PE taping reel; Reel 7 inch
- P = Paper/PE taping reel; Reel 13 inch

(4) TC MATERIAL

NPO

X7R

(5) RATED VOLTAGE

 $7 = 16 \vee 8 = 25 \vee$

9 = 50 V

(6) PROCESS

N = NP0B = class 2 material, X7R

(7) CAPACITANCE VALUE

2 significant digits+number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example: $|2| = |2 \times |0| = |20 \text{ pF}$



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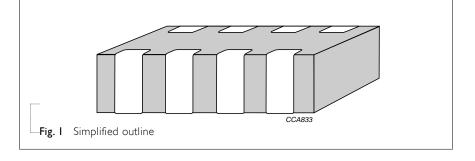
Surface-Mount Ceramic Multilayer Capacitors Automotive Array NP0/X7R 16 V to 50 V

CONSTRUCTION

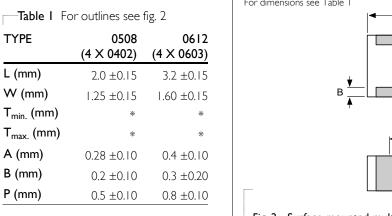
The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn).

The terminations are lead-free. An outline of the structure is shown in Fig. I.

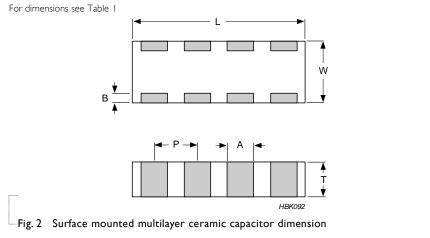


OUTLINES



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* Refer to Table 2 ~Table 3





<u>CAPACITANCE</u>	RANGE	સ	THICKNESS	FOR	4C-ARRAY

-Table 2 Temperature characteristic material from NP0

CAPACITANCE	0508 (4 × 0402) 50 ∨	0612 (4 × 0603)
		50 V
10 pF	0.6±0.1	0.8±0.1
I5 pF	0.6±0.1	0.8±0.1
18 pF	0.6±0.1	0.8±0.1
22 pF	0.6±0.1	0.8±0.1
33 pF	0.6±0.1	0.8±0.1
39 pF	0.6±0.1	0.8±0.1
47 pF	0.6±0.1	0.8±0.1
56 pF	0.6±0.1	0.8±0.1
68 pF	0.6±0.1	0.8±0.1
82 pF	0.6±0.1	0.8±0.1
100 pF	0.6±0.1	0.8±0.1
120 pF		0.8±0.1
150 pF		0.8±0.1
180 pF		0.8±0.1
220 pF		0.8±0.1
270 pF		0.8±0.1
330 pF		0.8±0.1
390 pF		0.8±0.1
470 pF		0.8±0.1
560 pF		
680 pF		
820 pF		
I.0 nF		

ΝΟΤΕ

Values in shaded cells indicate thickness class in mm



CAPACITANCE RANGE & THICKNESS FOR 4C-ARRAY

Table 3 Temperature characteristic material from X7R

CAPACITANCE	0508 (4 × 0402)			0612 (4×0603)		
	16 V	25 V	50 V	16 V	25 V	50 V
I.0 nF	0.6±0.1	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1	0.8±0.1
I.5 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
2.2 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
3.3 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
4.7 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
6.8 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
10 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
22 nF	0.6±0.1					
47 nF	0.6±0.1			0.8±0.1	0.8±0.1	
100 nF	0.6±0.1					

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Values in shaded cells indicate thickness class in mm

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THICKNESS CLASSES AND PACKING QUANTITY

Table 4							
SIZE	THICKNESS		Ø180	MM / 7 INCH	Ø330 MM / 13 INCH		
CODE	CLASSIFICATION	QUANTITY PER REEL	Paper	Blister	Paper	Blister	
0508	0.6 ±0.1 mm	8 mm	4,000		20,000		
0612	0.8 ±0.1 mm	8 mm	4,000		15,000		

ELECTRICAL CHARACTERISTICS

NP0/X7R DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

Table 5		
DESCRIPTION		VALUE
Capacitance range		10 pF to 100 nF
Capacitance tolerance		
NP0	C ≥ 10 pF	±5%
X7R		±10%, ±20%
Dissipation factor (D.F	.)	
NP0	C < 30 _P F	≤ / (400 + 20C)
	C ≥ 30 _P F	≤ 0.1%

X7R	0508 (Array)	0612 (Array)	
16V	InF to IOnF	220pF to 47nF	≤ 3.5%
	I5nF to I00nF		≤ 5%
25V	InF to IOnF	220pF to 47nF	≤ 2.5%
50V	InF	220pF to 10nF	≤ 2.5%
Insulation resist	ance after I minute at U _r (DC)	IR ≥ 10G Ω or 1.R x C ≥ 500 second	ls whichever is less

7

Surface-Mount Ceramic Multilayer Capacitors Automotive Array NP0/X7R 16 V to 50 V

SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C
- Endurance: 95 to 120 seconds ٠
- ٠ Cycles: 3 times

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202G-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

TESTS AND REQUIREMENTS

TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS				
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage				
Capacitance	IEC 60384- 21/22	4.5.1	Class I: At 20 °C, 24 hours after annealing $f = 1$ MHz for C \leq InF, measuring at voltage 1 V _{rms} at 20 °C f = 1 KHz for C > InF, measuring at voltage 1 V _{rms} at 20 °C Class 2: At 20 °C, 24 hours after annealing f = 1 KHz, measuring at voltage 1 V _{rms} at 20 °C	Within specified tolerance				
Dissipation Factor (D.F.)	IEC 60384- 21/22	4.5.2	Class I: At 20 °C, 24 hours after annealing $f = 1$ MHz for $C \le InF$, measuring at voltage 1 V _{rms} at 20 °C f = 1 KHz for $C > InF$, measuring at voltage 1 V _{rms} at 20 °C Class 2: At 20 °C, 24 hours after annealing f = 1 KHz, measuring at voltage 1 V _{rms} at 20 °C	In accordance with specification				
Insulation Resistance	IEC 60384- 21/22	4.5.3	At U_r (DC) for 1 minute	In accordance with specification				
High Temperature Exposure	AEC-Q200	3	Unpowered ; 1000hours @ T=150° C Measurement at 24±2 hours after test conclusion.	No visual damage $\Delta C/C$: Class1: NP0: within ±0.5% or 0.5 pF whichever is greater Class2: X7R: ±10% D.F.: within initial specified value IR: within initial specified value				

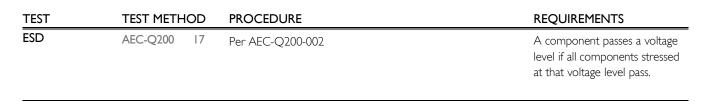


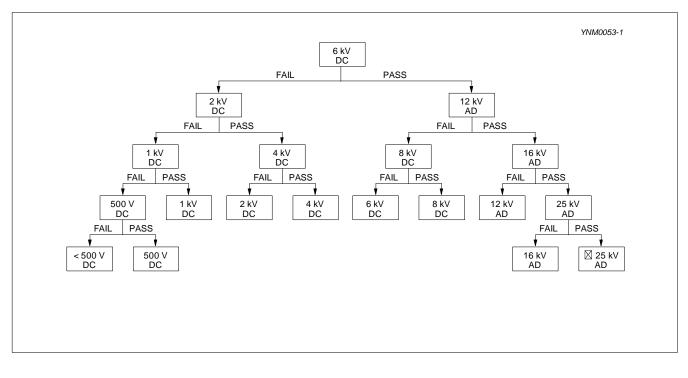
TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS				
Temperature Cycling	AEC-Q200	4	Preconditioning; 150 +0/–10 °C for 1 hour, then keep for	No visual damage				
	24 ±1 hours at room temperature 1000 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature Recovery time 24 ±2 hours		1000 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature	Δ C/C Class I: NP0: Within ±1% or 0.5pF, whichever is greater. Class2: X7R: ±10%				
				D.F. meet initial specified value IR meet initial specified value				
Destructive Physical Analysis	AEC-Q200	5	Note: Only applies to SMD ceramics. Electrical test not required.					
Moisture Resistance	AEC-Q200	6	T=24 hrs/per cycle; 10 continuous cycles unpowered. Measurement at 24 ±2 hours after test condition.	No visual damage				
				Δ C/C NP0: Within ±3% or 3 pF, whichever is greater X7R: ±15%				
				D.F. Within initial specified value IR NP0: \geq 10,000 M Ω X7R: Meet initial specified value				

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.4 Moisture resistant																															

TEST	EST TEST METHOD PROCEDURE							
Biased Humidity	AEC-Q200	7	I. Preconditioning, class 2 only: I50 +0/-10 °C /I hour, then keep for 24 ±1 hour at room temp	No visual damage after recovery				
			 Initial measure: Parameter: IR Measuring voltage: 1.5V ± 0.1 VDC Note: Series with 100 KΩ Test condition: 85 °C, 85% R.H. connected with 100 KΩ resistor, applied 1.5V/U_r for 1,000 hours. Recovery: Class1: 6 to 24 hours Class2: 24 ±2 hours Final measure: IR 	Initial requirement: Class I: - Connected to 100 K Ω : C \leq 10 nF: I.R \geq 10,000 M Ω or C $>$ 10 nF: (I.R-100 K Ω) \times C \geq 100s. Class2: - Connected to 100 K Ω : C \leq 25 nF: I.R \geq 4,000 M Ω or C $>$ 25 nF: (I.R-100 K Ω) \times C \geq 100s. Final measurement: The insulation resistance shall be greater than 0.1 time initial value.				
Operational Life	AEC-Q200	8	I. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for	No visual damage				
			 24 ±1 hour at room temp 2. Initial measure: Spec: refer to initial spec C, D, IR 3. Endurance test: 	Δ C/C NP0: Within ±2% or 1 pF, whichever is greater X7R: ±15%				
			Temperature: X7R: 125 °C	D.F.				
			 Specified stress voltage applied for 1,000 hours: Applied 2.0 × U_r s 4. Recovery time: 24 ±2 hours 	NP0: $\leq 2 \times$ specified value. X7R: $\leq 16V$: $\leq 7\%$ or specified value whichever is greater				
			5. Final measure: C, D, IR	\geq 25V: \leq 5% or specified value whichever is greater				
			Note: If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to <i>'IEC 60384 4.1"</i> and then the requirement shall be met.	IR NP0: ≥ 4,000 M Ω or IR × C _r ≥ 40s whichever is less X7R: ≥ 1,000 M Ω or IR× C _r ≥ 50s whichever is less				
External Visual	AEC-Q200	9	Any applicable method using × 10 magnification	In accordance with specification				
Physical Dimension	AEC-Q200	10	Verify physical dimensions to the applicable device specification.	In accordance with specification				

TEST								
Mechanical Shock	AEC-Q200	13	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500 g's Duration: 0.5 ms Velocity change: 15.4 ft/s Waveform: Half-sin	$\label{eq:constraint} \begin{array}{l} \Delta C/C \\ \text{NP0: Within } \pm 0.5\% \text{ or } 0.5 \text{ pF,} \\ \text{whichever is greater} \\ \times 7 \text{R: } \pm 10\% \\ \end{array} \\ \begin{array}{l} \text{D.F.} \\ \text{Within initial specified value} \\ \text{IR} \\ \text{Within initial specified value} \end{array}$				
Vibration	AEC-Q200	14	5 g's for 20 minutes, 12 cycles each of 3 orientations.	Δ C/C NP0: Within ±0.5% or 0.5 pF, whichever is greater X7R: ±10%				
				D.F: meet initial specified value IR meet initial specified value				
Resistance to Soldering Heat	AEC-Q200	15	Precondition: 150 +0/–10 °C for 1 hour, then keep for 24 ±1 hours at room temperature Preheating: 120 °C to 150 °C for 1 minute Solder bath temperature: 260 ±5 °C	Dissolution of the end face plating shall not exceed 25% o the length of the edge concerned				
			Dipping time: 10 ±0.5 seconds Recovery time: 24 ±2 hours	Δ C/C Class1: NP0: Within ±1% or 0.5 pF, whichever is greater. Class2: X7R: ±10%				
				D.F. within initial specified value IR within initial specified value				
Thermal Shock	AEC-Q200	16	 Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room a temp Initial measure: Spec: refer to initial spec C, D, IR Rapid change of temperature test: NP0/X7R: -55 °C to +125 °C; 300 cycles 15 minutes at lower category temperature; 15 minutes at upper category temperature. Recovery time: Class1: 6 to 24 hours 	No visual damage $\Delta C/C$ NP0: Within ± 1% or 1 pF, whichever is greater X7R: ±15% D.F: meet initial specified value IR meet initial specified value				
			4. Recovery time:					





Solderability	AEC-Q200	18	 Preheat at 155°C for 4 hours. After preheating, immerse the capacitor in a solution of ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 5+0/-0.5 seconds at 235±5°C. 	The solder should cover over 95% of the critical area of each termination.
			 Should be placed into steam aging for 8 hours±15 minutes. After preheating, immerse the capacitor in a solution of ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 5+0/-0.5 seconds at 235±5°C. 	
			3. Should be placed into steam aging for 8 hours±15 minutes. After preheating, immerse the capacitor in a solution of Ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 120±5 seconds at 260±5°C.	

Product specification 11

TEST	TEST METHOD		PROCEDURE	AC/C Class 1: NP0: ±30 ppm/°C Class2: X7R: ±15%	
Electrical Characterization	AEC-Q200 19		Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max operating temperatures. Class 1: NP0: -55 °C to +125 °C Normal temperature: 20 °C Class 2: X7R: -55 °C to +125 °C Normal temperature: 20 °C		
Board Flex	AEC-Q200	21	Part mounted on a 100 mm X 40 mm FR4 PCB board, which is 1.6 ±0.2 mm thick Part should be mounted using the following soldering reflow profile. Conditions: Class I: Bending 3 mm at a rate of 1 mm/s, radius jig 340 mm Class2: Bending 2 mm at a rate of 1 mm/s, radius jig 340 mm	No visible damage ΔC/C Class I: NP0: Within ±1% or 0.5 pF, whichever is greater Class2: X7R: ±10%	
Terminal Strength	AEC-Q200	22	With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested. This force shall be applied for 60+1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.	Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body, terminals and body/terminal junction. Before and after the test, the device shall comply with all electrical requirements stated in this specification.	
Beam Load Test	AEC-Q200	23	Place the part in the beam load fixture. Apply a force until the part breaks or the minimum acceptable force level required in the user specification(s) is attained.	0508: 20N 0612: 15N	
Voltage Proof			1. Specified stress voltage applied for $1 \sim 5$ seconds 2. Ur ≤ 100 V: applied 2.5 Ur	No breakdown or flashover	
			Charge/Discharge current is less than 50 mA		

<u>REVISION HISTORY</u>

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 0	July 09, 202 I	-	- New Datasheet

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